WHAT IS CLAIMED IS:

- 1. A negative-working photosensitive composition comprising:
 - (A) a film-forming polymer

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- (B) an unsaturated compound having a radical polymerizable ethylenic double bond,
 - (C) a photopolymerization initiator,
 - (D) a thermal/polymerization inhibitor, and
- (E) at least one member selected from compounds represented by the following formula:

$$SO_2NH_2$$
 or H_3C SO_2NH_2

in an amount of 3.5 wt% or less based on the weight of the photosensitive resin composition.

- 2. The negative-working photosensitive resin composition according to claim 1, wherein the amount of component (E) is in the range of 0.5 2.0 wt% based on the weight of the photosensitive resin composition.
- 3. The negative-working photosensitive resin composition according to claim 1, wherein the amount of component (E) is in

the range of 1.0 - 1.5 wt% based on the weight of the photosensitive resin composition.

- 4. The negative-working photosensitive resin composition according to claim 1, wherein component (E) is p-toluene-sulfonamide.
- 5. The negative-working photosensitive resin composition according to claim 1, wherein component (A) is a water-soluble polymer.